


Pressure Sensor
PS-A series

 Some product numbers are deprecated.
Not recommended for new design.



Built-in amplifier and compensating circuit

Feature

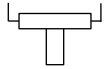
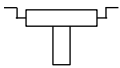
- Built-in amplifier and temperature compensation circuit, no need for circuit design and characteristic adjustment.
- High accuracy and reliability : overall accuracy $\pm 1.25\%$ FS (Standard), $\pm 2.5\%$ FS (Low-pressure type)
- Compact size, space-saving : compatible size for PS type (Standard/Economy, S and M packages)
- RoHS compliant

Typical applications

- Industrial use : Pressure switches and pneumatic components, compressed air pressure measuring devices
- Medical use : Airbeds
- Others : Pressure sensing devices for air pressure mediums [Low-pressure type]
- Water level detection for domestic appliances : Washing machines and dishwashers
- Air pressure control : Cleanrooms and smoking rooms

Ordering information

ADP5








Terminal profile	Code	Rated pressure	Code	Package/Pressure inlet hole	Code	Base type
1 : DIP terminal 	0	± 100 kPa	0	S package length : 3 mm 0.118 inch, dia : 3 mm 0.118 inch	Nil	With glass base (Standard type)
2 : SMD terminal 	1	-100 kPa	1	M package length : 5 mm 0.197 inch, dia : 3 mm 0.118 inch	1	Low pressure type Without glass base (Economy type)
	2	25 kPa				
	3	50 kPa	2	L package (Only low pressure type) length : 13.5 mm 0.531 inch, dia : 5.45 mm 0.215 inch	3	
	4	100 kPa				
	5	200 kPa				
	6	500 kPa				
	7	1000 kPa				
	A	40 kPa				
	B6	6 kPa (Low pressure type)		P package (Only low pressure type) length : 15.6 mm 0.615 inch, dia : 5.45 mm 0.215 inch		

Note : Some part numbers may not be available depending on the combination.
Please refer to the Table of PRODUCT TYPES on the next page.

Product types

Not Recommended for New Design

Standard packing : Carton : 100 pcs.; Case : 1,000 pcs.

Package (Pressure inlet hole length)		Part No.						
		Standard type S package (3 mm 0.118 inch)		Standard / Economy type M package (5 mm 0.118 inch)		Low pressure type		
Pressure	Terminal	DIP terminal 	SMD terminal 	DIP terminal 	SMD terminal 	DIP terminal 	DIP terminal 	DIP terminal 
Standard								
± 100 kPa		ADP5100	ADP5200	ADP5101	ADP5201	—	—	—
-100 kPa		ADP5110	ADP5210	ADP5111	ADP5211	—	—	—
25 kPa		ADP5120	—	ADP5121	—	—	—	—
50 kPa		ADP5130	—	ADP5131	—	—	—	—
100 kPa		ADP5140	ADP5240	ADP5141	ADP5241	—	—	—
200 kPa		ADP5150	ADP5250	ADP5151	ADP5251	—	—	—
500 kPa		ADP5160	ADP5260	ADP5161	ADP5261	—	—	—
1000 kPa		ADP5170	ADP5270	ADP5171	ADP5271	—	—	—
Economy type (without glass base)								
40 kPa		—	—	ADP51A11	—	—	—	—
Low pressure type								
6 kPa		—	—	—	—	ADP51B61	ADP51B62	ADP51B63

Rating

● Standard type

Not Recommended for New Design

Item	Standard type (with glass base)							
Type of pressure	Gauge pressure							
Pressure medium	Air ^{*1}							
Rated pressure (kPa)	±100	-100	25	50	100	200	500	1000
Max. applied pressure	Twice of the rated pressure							1.5 times the rated pressure
Ambient temperature	-10 °C to +60 °C 14 °F to +140 °F (no freezing or condensation)							
Storage temperature	-20 °C to +85 °C -4 °F to +185 °F (no freezing or condensation)							
Drive voltage	5±0.25 V							
Temperature compensation range	0 °C to 50 °C 32 °F to 122 °F							
Offset voltage ^{*2,3,5}	2.5±0.05	0.5±0.05 V						
Rated output voltage ^{*2,3,5}	4.5±0.05 (+when +100kPa)	4.5±0.05 V						
Overall accuracy	±1.25 %FS ^{*3,4,5}							
Current consumption	Max. 10 mA ^{*2,3}							
Output impedance	15 Ω (Typical) ^{*2}							
Source current	Max. 0.2 mA ^{*2,3}							
Sink current	Max. 2 mA ^{*2,3}							

*1: Please consult us for pressure media other than air.

*2: Indicates output when temperature is 25 °C 77 °F.

*3: Indicates output when drive voltage is 5 V. Although output fluctuates due to fluctuations in the drive voltage, this is not included.

*4: Overall accuracy indicates the accuracy of the offset voltage and rated output voltage at a temperature compensation range of 0 to 50 °C 32 to 122 °F.

*5: Accuracy is the value at the time of our shipping. Please set Zero-point calibration function on your products in order to safely use if the offset voltage is shifted.

● Economy type

Not Recommended for New Design

Item	Economy type (without glass base)	
Type of pressure	Gauge pressure	
Pressure medium	Air ^{*1}	
Rated pressure (kPa)	40	
Max. applied pressure	Twice of the rated pressure	
Ambient temperature	-5 °C to +50 °C 23 °F to +122 °F (no freezing or condensation)	
Storage temperature	-20 °C to +70 °C -4 °F to +158 °F (no freezing or condensation)	
Drive voltage	3±0.15 V	
Temperature compensation range	5 °C to 45 °C 41 °F to 113 °F	
Offset voltage	0.3±0.09 V ^{*2,3,5}	
Span voltage	2.4±0.03 V ^{*2,3,5}	
Offset voltage temperature characteristics	±4.0 %FS ^{*3,4,5}	
Sensitivity temperature characteristics	1.3 %FS ^{*3,4,5}	
Current consumption	Max. 3 mA ^{*2}	
Output impedance	20 Ω (Typical) ^{*2,3}	
Source current	Max. 0.15 mA ^{*2,3}	
Sink current	Max. 1.5 mA ^{*2,3}	

*1: Please consult us for pressure media other than air.

*2: Indicates output when temperature is 25 °C 77 °F.

*3: Indicates output when drive voltage is 3 V. Although output fluctuates due to fluctuations in the drive voltage, this is not included.

*4: Indicates from output value at 25 °C 77 °F and the change of output at 5 and 45 °C 41 to 113 °F.

*5: Accuracy is the value at the time of our shipping. Please set Zero-point calibration function on your products in order to safely use if the offset voltage is shifted.

Rating

● Low pressure type

ADP51B61, ADP51B62 : Not Recommended for New Design

Item	Economy type (without glass base)
Type of pressure	Gauge pressure
Pressure medium	Air ^{*1}
Rated pressure (kPa)	6
Max. applied pressure	Twice of the rated pressure
Ambient temperature	0 °C to +70 °C 32 °F to +158 °F (no freezing or condensation)
Storage temperature	-30 °C to +100 °C -22 °F to +212 °F (no freezing or condensation)
Drive voltage	5±0.25 V
Temperature compensation range	0 °C to 70 °C 32 °F to 158 °F
Offset voltage	0.5 V (Typical) ^{*2}
Span voltage	4.0 V (Typical) ^{*2}
Overall accuracy	±2.5 %FS ^{*2,3,4}
Current consumption	Max. 10 mA
Output impedance	50 Ω (Typical)
Source current	Max. 0.2 mA
Sink current	Max. 2.0 mA

*1: Please consult us for pressure media other than air.

*2: Indicates output when drive voltage is 5 V. Although output fluctuates due to fluctuations in the drive voltage, this is not included.

*3: Overall accuracy indicates the accuracy of the offset voltage and span voltage at temperatures between 0 to 70 °C 32 to 158 °F (FS=4V)

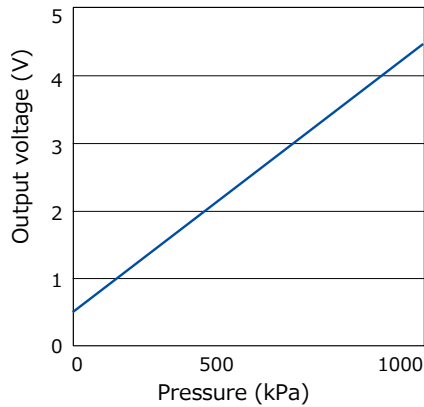
*4: The initial offset voltage error is not included in the overall accuracy.

Reference data

[Standard type]

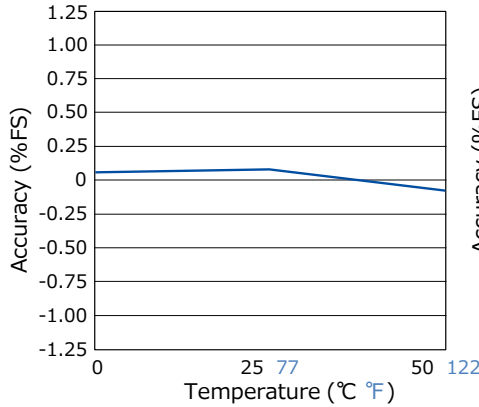
1. -① Output voltage

ADP5170
 Drive voltage : 5 V
 Temperature : 25 °C 77 °F
 Applied pressure : 0 to +1,000 kPa



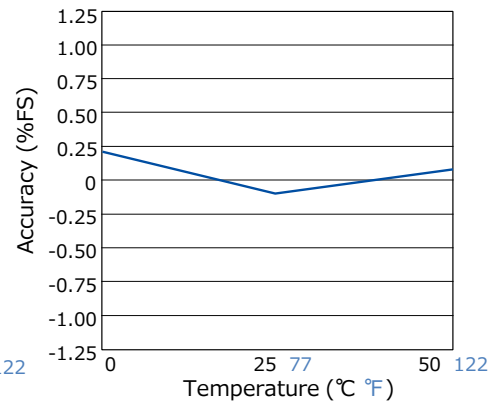
1. -② Overall accuracy (Offset voltage)

ADP5170
 Drive voltage : 5 V
 Temperature : 0 to 50 °C 32 to 122 °F
 Applied pressure : 0 kPa



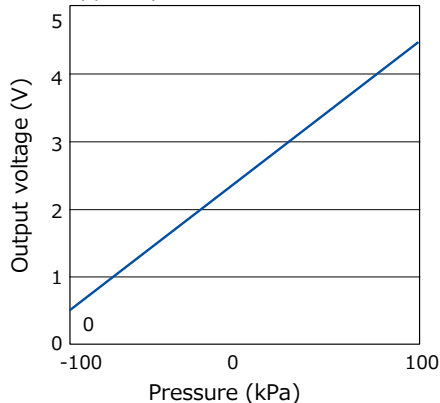
1. -③ Overall accuracy (Rated output voltage)

ADP5170
 Drive voltage : 5 V
 Temperature : 0 to 50 °C 32 to 122 °F
 Applied pressure : +1,000 kPa



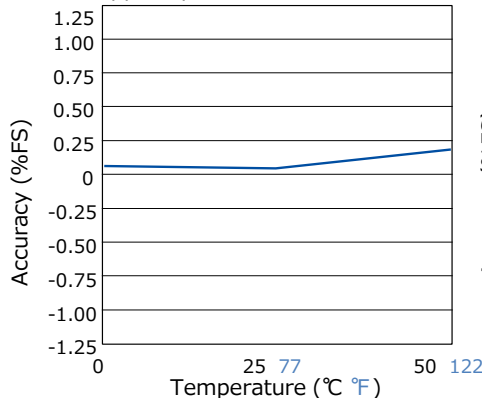
2. -① Output voltage

ADP5100
 Drive voltage : 5 V
 Temperature : 25 °C 77 °F
 Applied pressure : -100 to +100 kPa



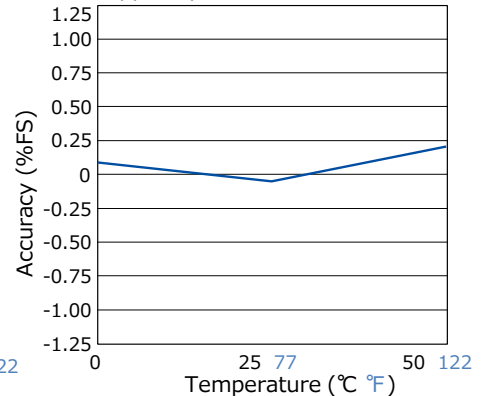
2. -② Overall accuracy (Offset voltage)

ADP5100
 Drive voltage : 5 V
 Temperature : 0 to 50 °C 32 to 122 °F
 Applied pressure : 0 kPa



2. -③ Overall accuracy (Rated output voltage)

ADP5100
 Drive voltage : 5 V
 Temperature : 0 to 50 °C 32 to 122 °F
 Applied pressure : +100 kPa



Reference data

[Low pressure type]

ADP51B61 : Not Recommended for New Design

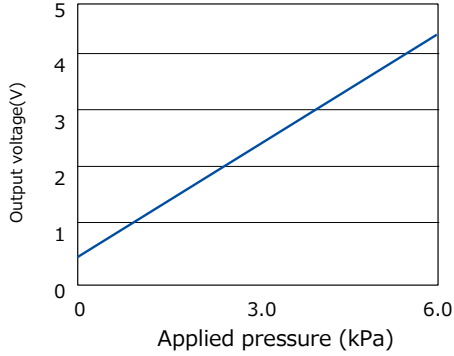
1. Output voltage

ADP51B61

Drive voltage : 5 V

Temperature : 25 °C 77 °F

Applied pressure : 0 to 6 kPa



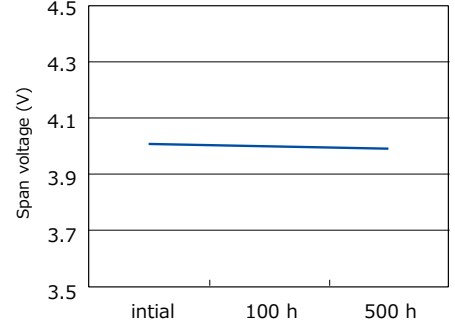
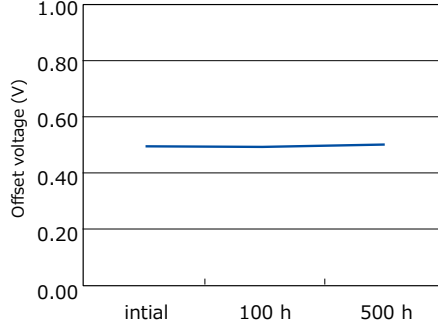
2. THB (high temperature high humidity bias test)

ADP51B61

Within 85 °C 185 °F and 85% RH

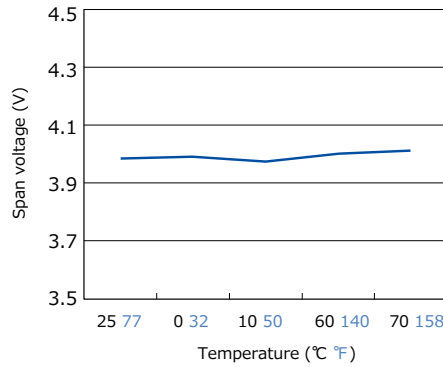
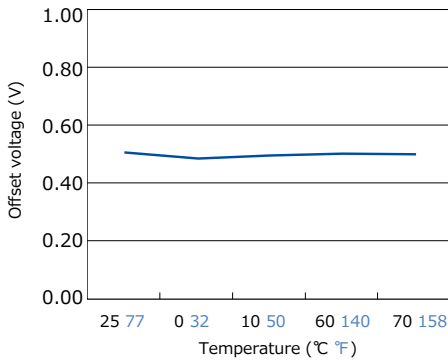
5 V applied between No.2 (Vdd) and No.3 (GND)

Applied pressure : 0 kPa



3. Ambient temperature characteristics

Ambient temperature : 25 °C 77 °F → 0 °C 32 °F → 10 °C 50 °F → 60 °C 140 °F → 70 °C 158 °F

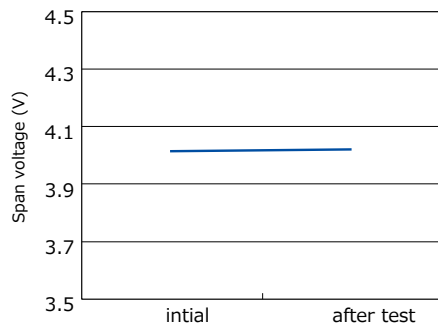
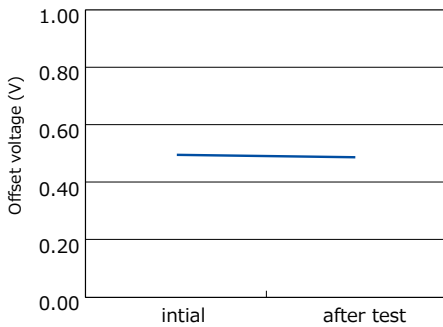


4. Shock test

ADP51B61

Shock applied (981 m/s², 3 times in x, y and z directions)

Applied pressure : 0 kPa

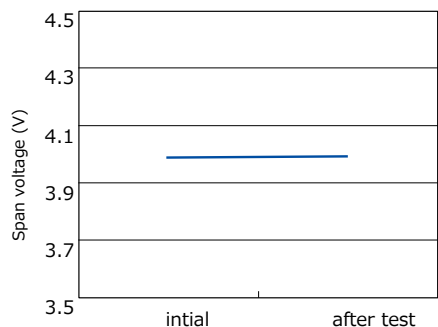
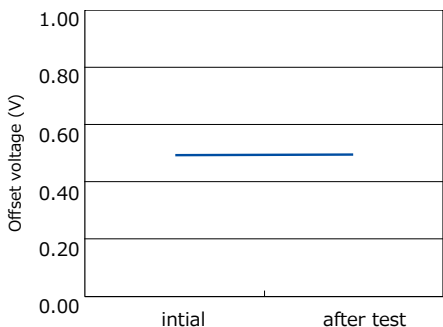


5. Vibration test

ADP51B61

Vibration applied (10 to 55 Hz, amplitude : 1.5mm, x, y and z directions, 2 hrs each)

Applied pressure : 0 kPa



Reference data

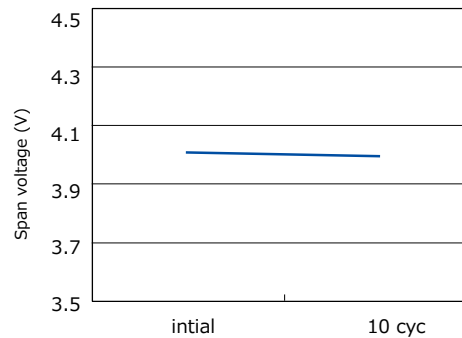
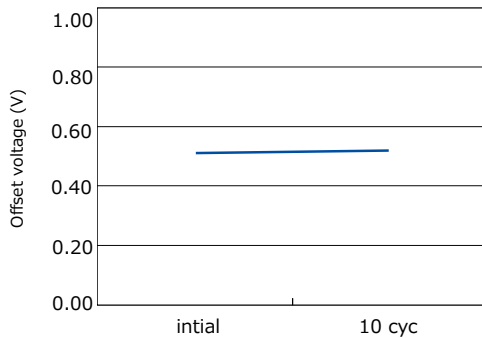
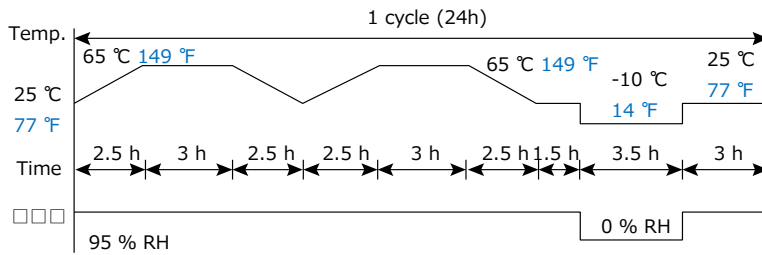
6. Temperature/humidity cycle test

ADP51B61 : Not Recommended for New Design

ADP51B61

Exposed to 10 cycles in the temperature and humidity conditions given below.

Applied pressure : 0 kPa



Evaluation test

Classification	Tested item	Tested condition	Result
Environmental characteristics	Storage at high temperature	Temperature : Left in a 85 °C 185 °F constant temperature bath Time : 100 hrs	Passed
	Storage at low temperature	Temperature : Left in a -20 °C -4 °F constant temperature bath Time : 100 hrs	Passed
	Humidity	Temperature/humidity : Left at 40 °C 104 °F, 90 % RH Time : 100 時間	Passed
	Temperature cycle	Temperature : -20 °C to 85 °C -4 °F to 185 °F 1 cycle : 30 min Times of cycle : 100 cycle	Passed
Endurance characteristics	High temperature/high humidity operation	Temperature/humidity : 40 °C 104 °F, 90% RH Operation times : 10 ⁶ , rated voltage applied	Passed
Mechanical characteristics	Vibration resistance	Double amplitude : 1.5 mm 0.059 inch Vibration : 10 to 55 Hz Applied vibration direction : X, Y, Z 3 directions Time : 2 hrs each	Passed
	Dropping resistance	Dropping height : 75 cm 29.528 inch Times : 2 times	Passed
	Terminal strength	Pulling strength : 9.8 N {1 kgf}, 10 sec Bending strength : 4.9 N {0.5 kgf}, left and right 90 ° 1 time	Passed
Soldering characteristics	Solderability	Temperature : 230 °C 446 °F Time : 5 sec	Passed
	Heat resistance (DIP)	Temperature : 260 °C 500 °F Time : 10 sec	Passed

Note: For details other than listed above, please consult us.

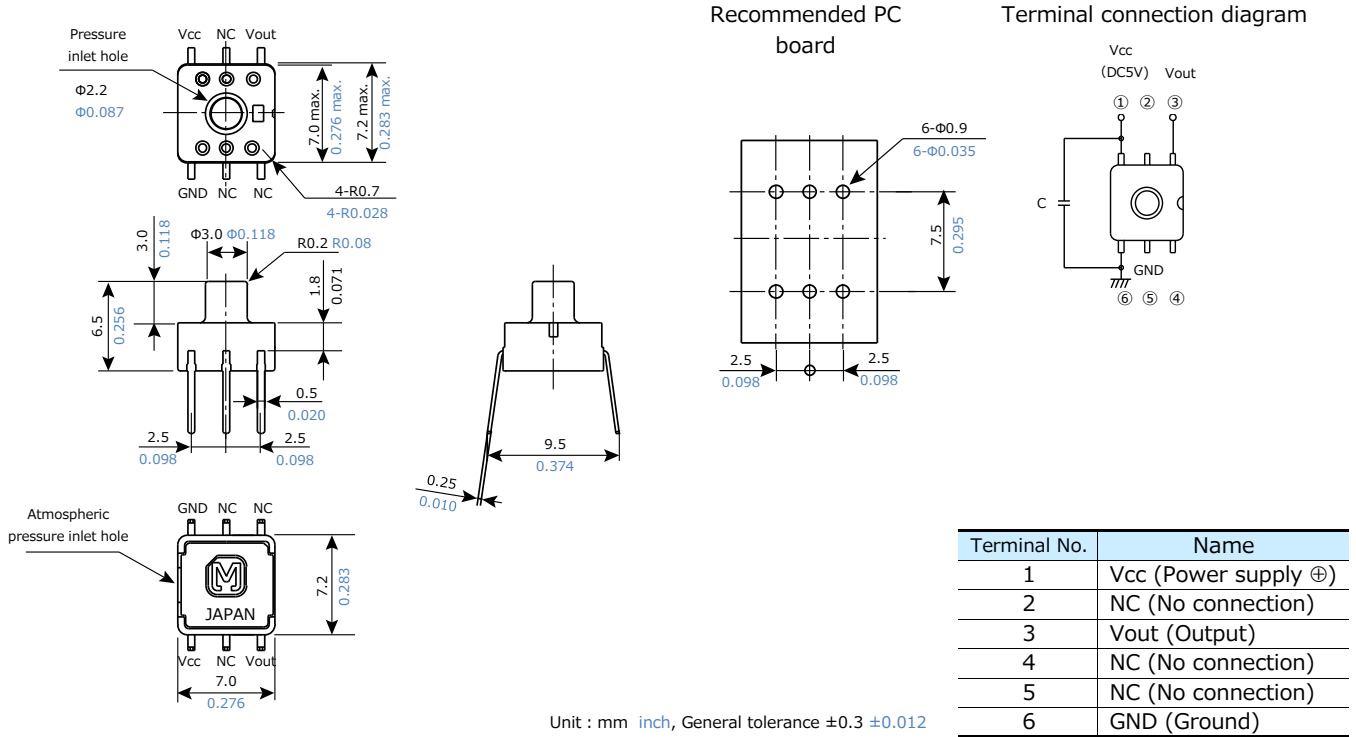
Items	Criteria
Offset voltage	Variation amount
Output span voltage	within ±2.5 %FS of value

Dimensions

The CAD data of the products with a **CAD data** mark can be downloaded from: <http://industrial.panasonic.com/>

- Standard type S package (Terminal direction : DIP terminal Pressure inlet hole length : 3 mm 0.118 inch)

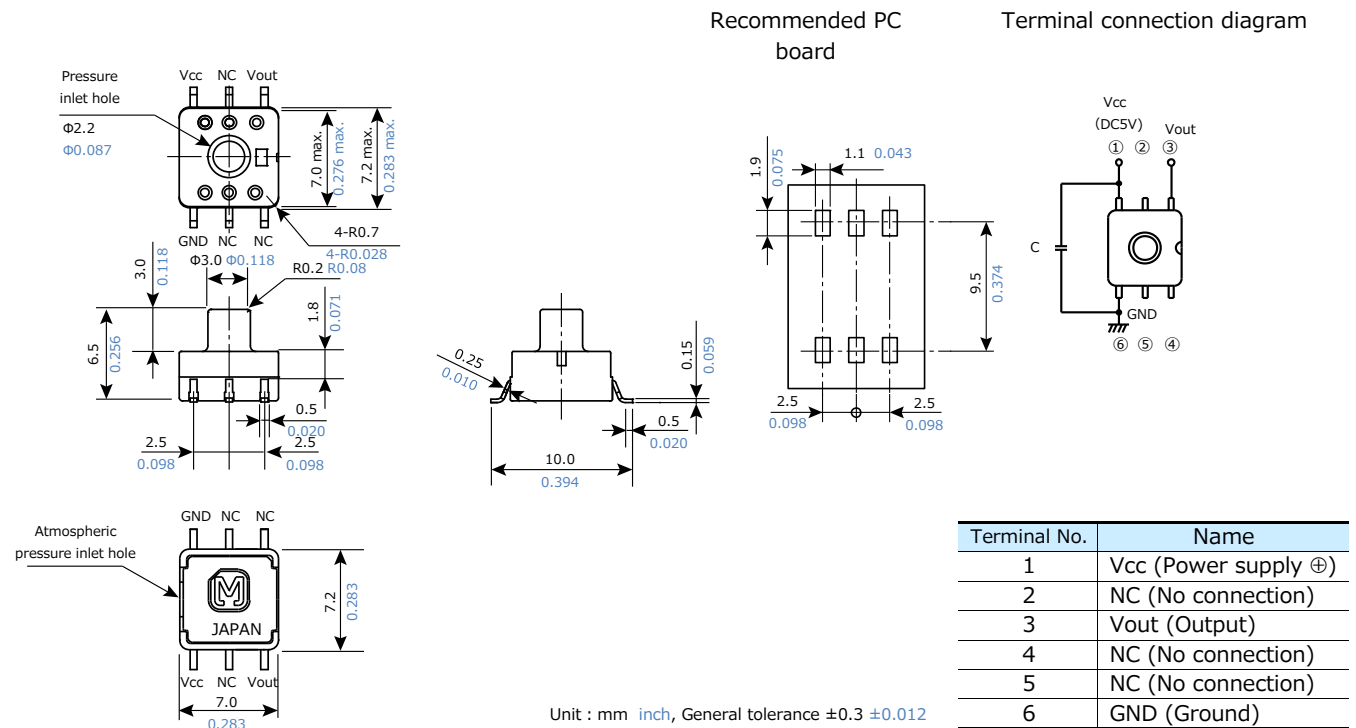
CAD data



Unit : mm inch, General tolerance ±0.3 ±0.012

- Standard type S package (Terminal direction : SMD terminal Pressure inlet hole length : 3 mm 0.118 inch) ADP52□□

CAD data



Unit : mm inch, General tolerance ±0.3 ±0.012

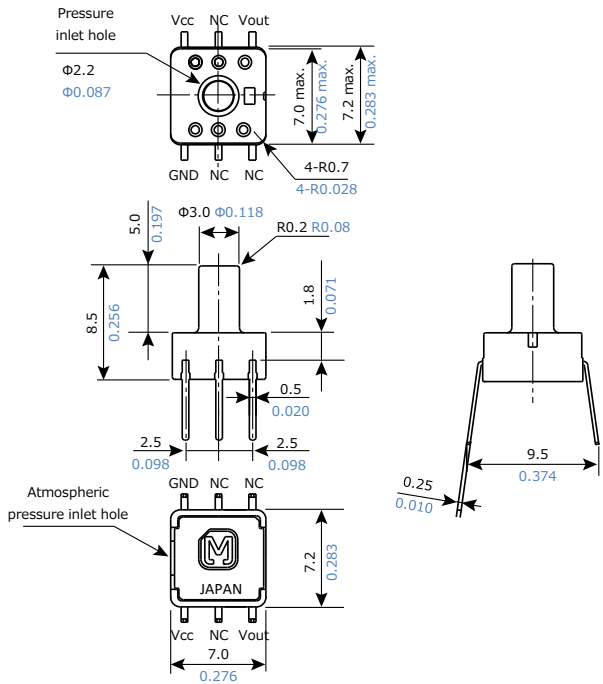
Dimensions

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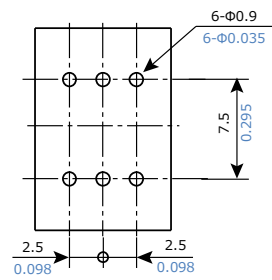
Not Recommended for New Design

- Standard/Economy type M package (Terminal direction : DIP terminal Pressure inlet hole length : 5 mm 0.197 inch)
ADP51□1/ADP51A11

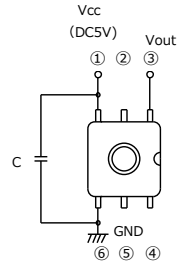
CAD data



Recommended PC board



Terminal connection diagram

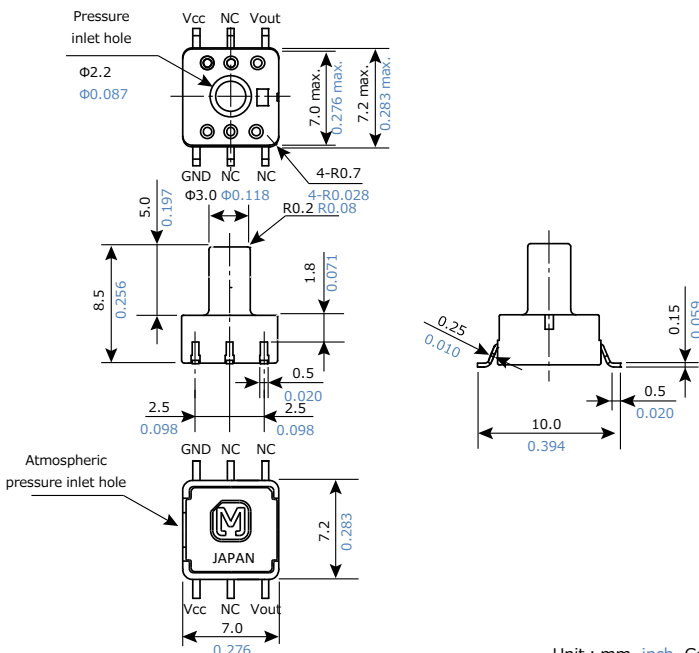


Terminal No.	Name
1	Vcc (Power supply ⊕)
2	NC (No connection)
3	Vout (Output)
4	NC (No connection)
5	NC (No connection)
6	GND (Ground)

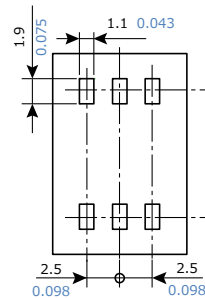
Unit : mm inch, General tolerance ±0.3 ±0.012

- Standard type M package (Terminal direction : SMD terminal Pressure inlet hole length : 5 mm 0.197 inch) ADP52□1

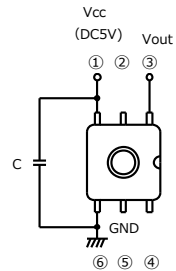
CAD data



Recommended PC board



Terminal connection diagram



Terminal No.	Name
1	Vcc (Power supply ⊕)
2	NC (No connection)
3	Vout (Output)
4	NC (No connection)
5	NC (No connection)
6	GND (Ground)

Unit : mm inch, General tolerance ±0.3 ±0.012

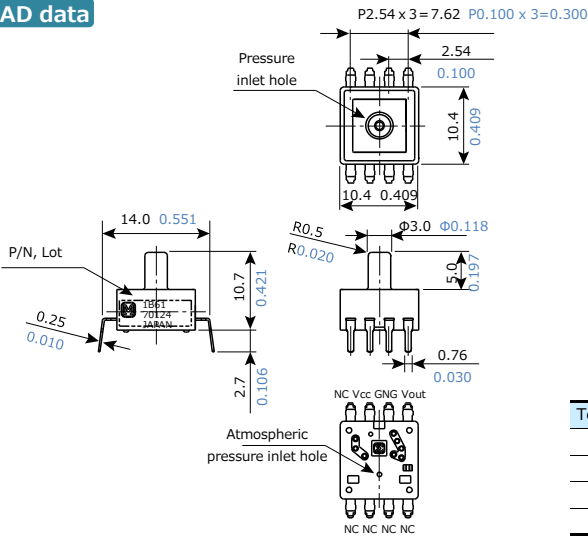
Dimensions

The CAD data of the products with a **CAD data** mark can be downloaded from: <http://industrial.panasonic.com/>

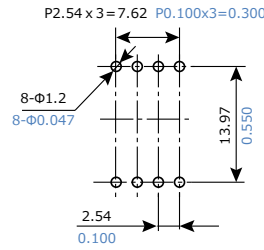
Not Recommended for New Design

- Low pressure type M package (Terminal direction : DIP terminal, Pressure inlet hole length : 5 mm 0.197 inch) ADP51B61

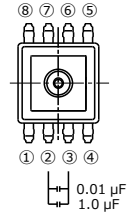
CAD data



Recommended PC board pattern (TOP VIEW)



Terminal connection diagram



Unit : mm inch, General tolerance ±0.3 ±0.012

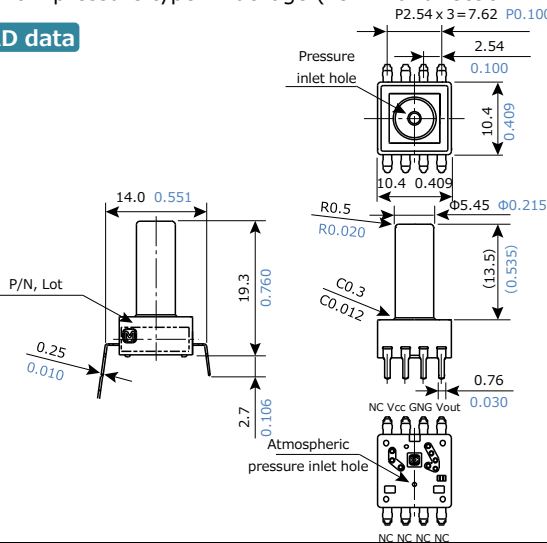
Terminal No.	Name
1	NC (No connection)
2	Vcc (Power supply⊕)
3	GND (Ground)
4	Vout (Output)

Terminal No.	Name
5	NC (No connection)
6	NC (No connection)
7	NC (No connection)
8	NC (No connection)

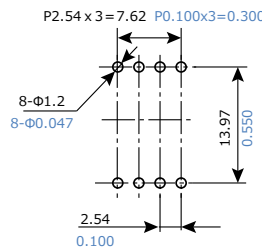
Not Recommended for New Design

- Low pressure type L Package (Terminal direction : DIP terminal, Pressure inlet hole length : 13.5 mm 0.531 inch) ADP51B62

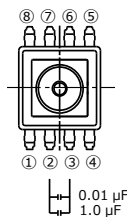
CAD data



Recommended PC board pattern (BOTTOM VIEW)



Terminal connection diagram



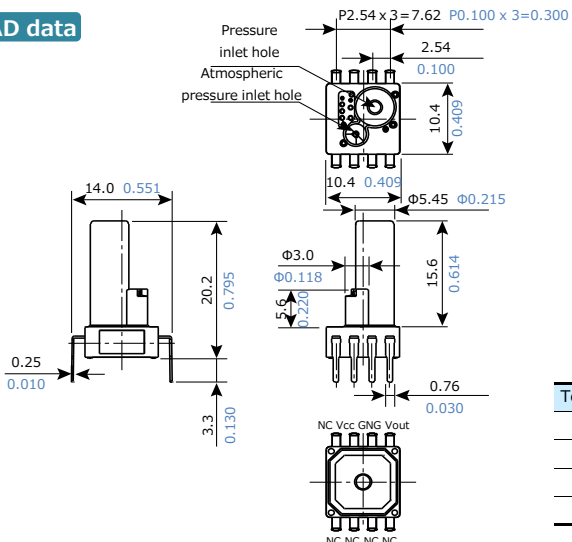
Unit : mm inch, General tolerance ±0.3 ±0.012

Terminal No.	Name
1	NC (No connection)
2	Vcc (Power supply⊕)
3	GND (Ground)
4	Vout (Output)

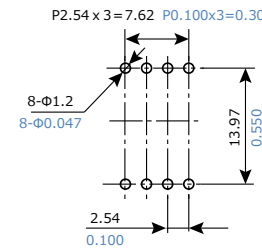
Terminal No.	Name
5	NC (No connection)
6	NC (No connection)
7	NC (No connection)
8	NC (No connection)

- Low pressure type P package (Terminal direction : DIP terminal, Pressure inlet hole length : 15.6 mm 0.614 inch) ADP51B63

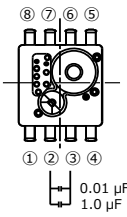
CAD data



Recommended PC board pattern (BOTTOM VIEW)



Terminal connection diagram



Unit : mm inch, General tolerance ±0.3 ±0.012

Terminal No.	Name
1	NC (No connection)
2	Vcc (Power supply⊕)
3	GND (Ground)
4	Vout (Output)

Terminal No.	Name
5	NC (No connection)
6	NC (No connection)
7	NC (No connection)
8	NC (No connection)

EXPLANATION OF TERMS

■ Pressure object

This is what can be used to activate the pressure sensor.
(The Panasonic Corporation pressure sensor can be used with gas.)

■ Rated pressure

The pressure value up to which the specifications of the pressure sensor are guaranteed.

■ Maximum applied pressure

The maximum pressure that can be applied to the pressure sensor, after which, when the pressure is returned to below the rated pressure range, the specifications of the pressure sensor are guaranteed.

■ Temperature compensation range

The temperature range across which the specification values of the pressure sensor are guaranteed.

■ Drive current (voltage)

The supply current (voltage) required to drive a pressure sensor.

■ Output span voltage

The difference between the rated output voltage and the offset voltage. The output span voltage is also called the full-scale voltage (FS).

■ Offset voltage

The output voltage of a pressure sensor when no pressure is applied.

■ Rated pressure output voltage

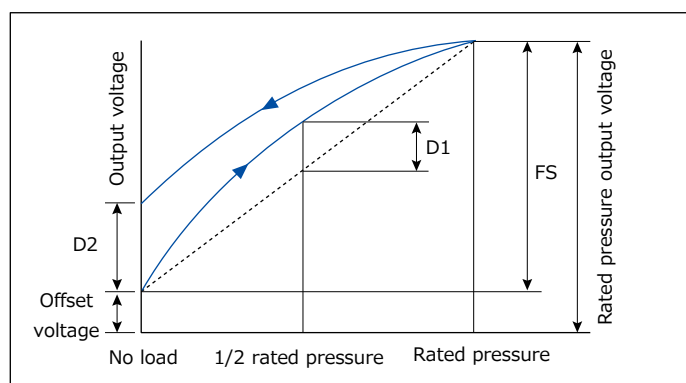
Output voltage when rated pressure is applied.

■ Linearity

When the pressure is varied from no load to the rated pressure, the linearity is the amount of shift between the straight line that joins the no-load voltage value and the rated pressure voltage value (expressed as the ratio of the amount of shift (D1) at half of the rated pressure value with respect to the full scale voltage (FS)).

■ Output hysteresis

The ratio of the difference (D2) in the no-load output voltages when the pressure is varied from no load to the rated pressure then reduced back to no load, with respect to the full scale voltage (FS).



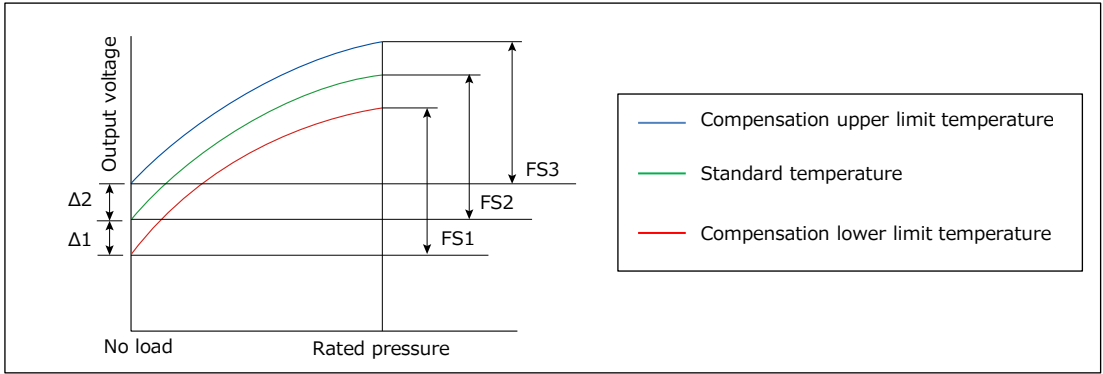
■ Offset voltage temperature characteristic

The variation of the offset voltage with changes in ambient temperature. The difference between the offset voltage at the standard temperature and the offset values at the compensation lower limit temperature (low temperature) (D1) and compensation upper limit temperature (high temperature) (D2) are obtained, and the offset voltage temperature characteristic is expressed as the ratio of the larger of these two differences (absolute) with respect to the full scale voltage (FS).

EXPLANATION OF TERMS

■ **Temperature sensitivity characteristic**

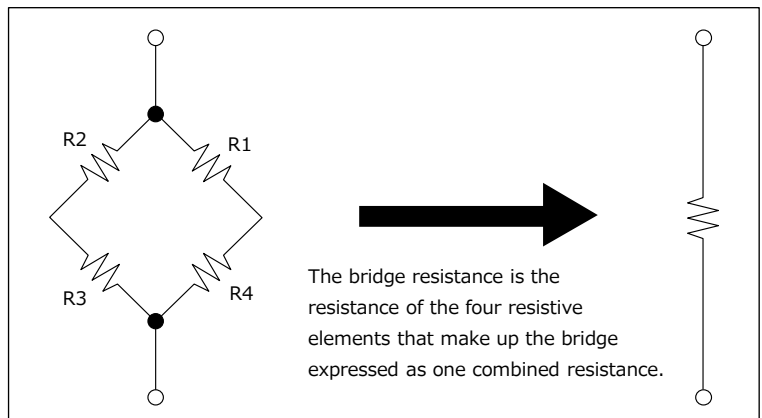
The variation of the sensitivity with changes in ambient temperature (variation in full scale (FS)). The difference between the full scale voltage at the standard temperature (FS) and the full scale values at the compensation lower limit temperature (low temperature) (FS1) and compensation upper limit temperature (high temperature) (FS2) are obtained, and the offset voltage temperature characteristic is expressed as the ratio of the larger of these two differences (FS1 - FS and FS2 - FS (absolute)) with respect to the full scale voltage (FS).



■ **Bridge resistance**

Refers to the resistance value of a piezo resistance formed on a monolithic silicon substrate. For example, the values of the resistances R1 to R4 in the bridge are typically 5 k Ω each.

* When the resistances of the resistive elements R1 to R4 that comprise the bridge are 5 k Ω each, the equivalent composite resistance of the bridge is 5k Ω (3 k Ω bridges are also available).



■ **Overall accuracy**

Accuracy of offset voltage and rated pressure output voltage within the temperature compensation range.

Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.
- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.
- If you use our products in equipment that requires a high degree of reliability, regardless of the application, it is recommended that you set up protection circuits and redundancy circuits in order to ensure safety of your equipment.
- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.
- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.
- If any of our products, product specifications and/or technical information in this online catalog is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

<Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

We do not take any responsibility for the use of our products outside the scope of the specifications, descriptions, guidelines and precautions described in this online catalog.

Safety precautions

- Do not use these sensors under any circumstances in which the range of their ratings, environment conditions or other specifications are exceeded. Using the sensors in any way which causes their specifications to be exceeded may generate abnormally high levels of heat, emit smoke, etc., resulting in damage to the circuitry and possibly causing an accident.
- Before connecting a connector, check the pin layout by referring to the connector wiring diagram, specifications diagram, etc., and make sure that the connector is connected properly. Take note that mistakes made in connection may cause unforeseen problems in operation, generate abnormally high levels of heat, emit smoke, etc., resulting in damage to the circuitry.
- Do not use any motion sensor which has been disassembled or remodeled.
- Protection circuit recommended.
The possible failure mode is either open or short of the output transistor.
An excess heat is the cause for short mode failure. For any important and serious application in terms of safety, add protection circuit or any other protection method.
 - Various safety equipment and safety equipment
 - Traffic light
 - Security crime prevention equipment
 - Equipment concerning control and safety of trains, cars, etc.
 - Applications such as temperature control using sensor output etc.
- If it is expected that malfunction of each sensor may cause injury to persons or serious expansion damage, be sure to implement safety measures such as double safety circuit.

Request for ordering and use

The products and specifications listed in this document are subject to change for product improvement, etc. (including specification changes and discontinued manufacturing). When examining mass-production design or placing an order for the listed products, please contact Panasonic to make sure that the information listed in this document is up-to-date.

- If it is expected that malfunction of each sensor may cause injury to persons or serious expansion damage, be sure to implement safety measures.
 - Reference Standards : Computers, office automation equipment, communications equipment, audio-video products, home electrical appliances, machine tools, personal devices, industrial robots.
 - Special Standards : Transportation equipment (automobiles, trains, ships, etc.), traffic signal equipment, crime and disaster prevention devices, electric power equipment, various safety devices, and medical equipment not directly targeted for life support
 - Specified Standards : Aircraft equipment, aeronautical and space equipment, seabed relay equipment, nuclear power control systems, and medical equipment, devices and systems for life support.
- Before considering the use of our products under the following conditions, you must contact one of our customer service representatives without fail and exchange written specifications.
 - When our products are to be used in any of the applications listed for the Special Standards or Specified Standards.
 - When, even for any of the applications listed for the Reference Standards, our products may possibly be used beyond the range of the specifications, environment or conditions listed in the document or when you are considering the use of our products in any conditions or an environment that is not listed in the document.

[Acceptance Inspection]

For a purchased or delivered product, please conduct an acceptance inspection promptly with adequate consideration given to the management and maintenance of the product before and during the acceptance inspection.

[Warranty Period]

The warranty period of these products is one year after the purchase or delivery to a location designated by your company, unless otherwise specified by both parties.

[Scope of Warranty]

If a failure or a defect attributable to Panasonic is found during the warranty period, we will promptly provide a replacement or a necessary replacement part or change/repair the defective part free of charge at the location of the purchase or delivery.

The warranty does not cover a failure or a defect when any of the following applies :

- (1) Caused by specifications, standards, or handling methods, etc. designated by your company.
- (2) Caused by modification of the structure, capabilities, or specifications, etc., in which Panasonic is not engaged, carried out after the purchase or delivery.
- (3) Caused by an unforeseen phenomenon that cannot be predicted with the technologies available after the time of the purchase or at the time of concluding the agreement.
- (4) When the product was used outside the scope of the conditions/environments described in the catalog or specifications.
- (5) When the product is incorporated in your company's equipment for use, damages that could be avoided if your company's equipment had industry-standard functions, structures, etc.
- (6) Caused by natural disasters or Force Majeure.

The warranty described here is limited to the purchased or delivered product only and does not cover any consequential damages arising from the failure or defect of the product.

[Before Purchase]

- The standard prices of the products listed in this catalog do not include consumption tax, delivery, installation & adjustment fees, used product collection fees, etc.
- The specifications/appearance are subject to change without notice for product improvement.
- The export of products that fall into the category of strategic goods (or services) require an export (or a service transaction) license under the Foreign Exchange and Foreign Trade Law. Please contact Panasonic for details.
- For details of the products listed in this catalog, please contact distributors, specialty contractor stores, or Panasonic.

Notes

■ Mounting

Use the land of the printed-circuit board on which the sensor is securely fixed.

■ Soldering

Avoid the external thermal influence as the product has a limited thermal capacity due to its compact structure. Heat deformation may damage the sensor or deteriorate its performance. Use the non-corrosive rosin flux. Prevent the flux from entering into the inside of the product as the sensor is exposed to the atmosphere.

(1) Manual soldering

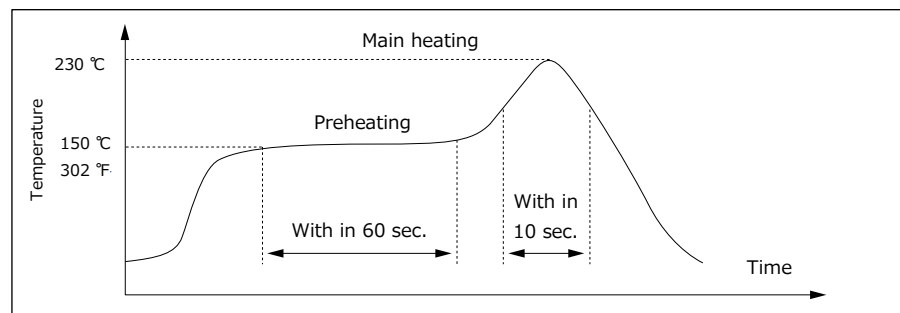
- Raise the temperature of the soldering tip between 260 and 300 °C 500 and 572 °F (30 W) and solder within 5 seconds.
- The sensor output may vary if the load is applied on the terminal during soldering.
- Keep the soldering tip clean.

(2) DIP soldering (DIP Terminal)

- Keep the temperature of the DIP solder tank below 260 °C 500 °F and solder within 5 seconds.
- To avoid heat deformation, do not perform DIP soldering when mounting on the circuit board which has a small thermal capacity.

(3) Reflow soldering (SMD Terminal)

- The recommended reflow temperature profile conditions are given below.



- We recommend the screen solder printing method as the method of cream.
 - Please refer to the recommended PC board specification diagram for the PC board foot pattern.
 - Self alignment may not always work as expected, therefore, please carefully the position of the terminals and pattern.
 - The temperature of the profile is assumed to be a value measured with the printed wiring board of the terminal neighborhood.
 - Please evaluate solderability under the actual mounting conditions since welding and deformation of the pressure inlet port may occur due to heat stress depending on equipments or conditions.
- (4) Rework soldering
- Complete rework at a time.
 - Use a flattened soldering tip when performing rework on the solder bridge. Do not add the flux.
 - Keep the soldering tip below the temperature described in the specifications.
- (5) Avoid drop and rough handling as excessive force may deform the terminal and damage soldering and rough handling as excessive force may deform the terminal and damage soldering
- (6) Keep the circuit board warpage within 0.05 mm of the full width of the sensor.
- (7) After soldering, do not apply stress on the soldered part when cutting or bending the circuit board.
- (8) Prevent human hands or metal pieces from contacting with the sensor terminal.
Such contact may cause anomalous outlets as the terminal is exposed to the atmosphere.
- (9) After soldering, prevent chemical agents from adhering to the sensor when applying coating to avoid insulation deterioration of the circuit board.
- (10) Please consult us concerning leadfree soldering.

■ Wire connection

- (1) Correctly wire as in the connection diagram. Reverse connection may damage the product and degrade the performance.
- (2) Do not use idle terminals to prevent damages to the sensor.

■ Cleaning

- (1) Prevent cleaning liquid from entering the inside of the product as the sensor is exposed to the atmosphere.
- (2) Do not perform ultrasonic cleaning in order to prevent damages to the product.

Notes

■ Environment

- (1) Avoid use and storage in the corrosive gas (organic solvent, sulfurous acid and hydrogen sulfide gases) which negatively affects the product.
- (2) Install the capacitor on the power supply terminal of the sensor and stabilize supply voltage to maintain a superimposed noise resistance. Recommended installation is to arrange 0.1 μ F and 1,000 pF in parallel. Before use, check the noise resistance and select/add the optimal capacitor.
- (3) Use surge absorbers as applying the external surge voltage may damage the internal circuit.
- (4) Malfunction may occur near electric noises from static electricity, lightning, broadcast or amateur radio stations and mobile phones
- (5) Avoid use in a place where these products come in contact with water as the sensor does not have a splash proof construction.
- (6) Avoid use in an environment where these products cause dew condensation. When water attached to the sensor chip freezes, the sensor output may be fluctuated or damaged.
- (7) Due to the structure of the pressure sensor chip, the output varies under light. Do not expose the sensor chip to light when applying a voltage by using a transparent tube.
- (8) Do not apply high-frequency oscillation, such as ultrasonic waves, to the product.

■ Quality check under actual use conditions

These specifications are for individual components. Before use, carefully check the performance and quality under actual use conditions to enhance stability.

■ Other precautions

- (1) The wrong mounting method and the pressure range may invite the risk of accidents.
- (2) Only applicable pressure medium is dry air. Avoid use in the corrosive gas (organic solvent, sulfurous acid and hydrogen sulfide gases) or other mediums containing moisture or foreign substances. Such mediums may damage or break the product.
- (3) The pressure sensor chip is located inside the pressure introduction port. Do not insert foreign substances, such as wires, into the port as those substances may damage the chip and close the port. Do not block the atmosphere introduction port.
- (4) Use electric power within the rated power range. Use beyond the range may damage the product.
- (5) Follow below instructions as static electricity may damage the product.
 - For Storage, short the circuit between terminals by using conductive substances or wrap the whole chip with aluminum foil. For storage and transportation, avoid plastic containers which are easily electrified.
 - Before use, connect electrified materials on desk and operators to the ground in order to safely discharge static electricity.
- (6) Carefully select and fix tubes, introduction pipes and products based on the working voltage. Please contact us for any inquires.
- (7) After mounding the pressure sensor, prevent the potting agent from entering the pressure and the atmosphere introduction ports when coating the circuit board. Use the elastic resin as the heated resin may expand, contract and apply pressure to the sensor. After coating, carefully check if the sensor can be used.